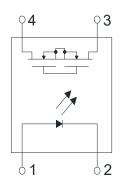
4PIN 60V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Description

The KAQY412 series is robust, ideal for telecom and ground fault applications. It is a SPST normally close switch (1 Form B) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, is comprised of a photodiode array, switch control circuitry and MOSFET switches.

Schematic



1 FORM B NORMALLY CLOSE



Features

- 1. Normally close, single pole single throw
- 2. Control 60V AC or DC voltage
- 3. Switch 200mA loads
- 4. Controls low-level analog signals
- 5. High sensitivity, low ON resistance
- 6. Low-level off-state leakage current
- 7. High isolation voltage 5KV (DIP / SMD)
- 8. Pb free and RoHS compliant
- 9. MSL class 1
- 10. Agency Approvals:
 - UL Approved (No. E169586, E108430): UL1577, UL508
 - c-UL Approved (No. E169586, E108430)
 - VDE Approved (No. 40053989): EN60747-5-5

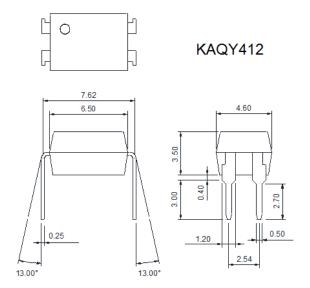
Application

- Telecommunications (PC, electronic notepad)
- Modem
- Telephone equipment
- · Security equipment
- Sensors
- Measuring and testing equipment
- · Factory automation equipment
- · High speed inspection machines

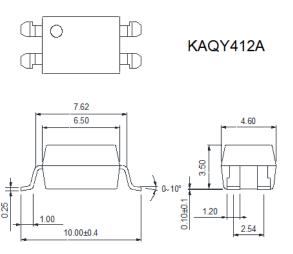
Unit: mm

• Outside Dimension

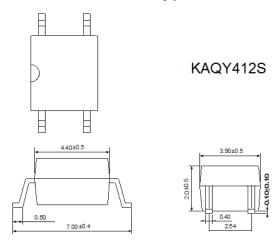
1. Dual-in-line type.



2. Surface mount type.

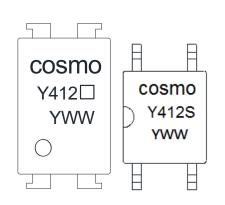


3. Small outline for surface mount type.



TOLERANCE: ±0.2mm

Device Marking



Notes:

cosmo

Y412 \square (Blank) : DIP or SMD

Y412S S: SOP

YWW Y: Year code / W: Week code

4PIN 60V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Absolute Maximum Ratings

(Ta=25°ℂ)

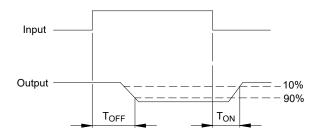
ltem		Symbol	Rating	Unit
Input	Continuous forward current	I _F	50	mA
	Peak forward current	I _{FP}	1	А
	Reverse voltage	V_R	5	V
	Power dissipation	P _{in}	100	mW
	Derate linearly from 25°C	-	1.3	mW/°C
	Breakdown voltage	V _B	60	V
Output	Continuous load current	ΙL	200	mA
	Power dissipation	P _{out}	500	mW
Isolation voltage		V	KAQY412S	KAQY412
		V_{iso}	1500Vrms	5000Vrms
Isolation resistance (Vio=500V)		R _{iso}	$\geq 10^{10}$	Ω
Total power dissipation		Pt	550	mW
Derate linearly from 25°C		-	2.5	mW/°C
Operating temperature		T _{opr}	-40 to +85	$^{\circ}\!\mathbb{C}$
Storage temperature		T _{stg}	-40 to +125	$^{\circ}\!\mathbb{C}$
Junction temperature		T _j	100	$^{\circ}\! \mathbb{C}$
Soldering temperature 10 seconds		T _{sot}	260	$^{\circ}\!\mathbb{C}$

• Electro-optical Characteristics

(Ta=25°ℂ)

	Parameter	Symbol	Conditions	Min.	Avg.	Max.	Unit
	Forward voltage	V _F	I _F =10mA	-	1.2	1.5	V
Input	Operation input current	I _{FOFF}	V _L =20V, I _L ≦5μA	-	-	3.0	mA
	Recovery input current	I _{FON}	V _L =20V, I _L =100mA	0.2	-	-	mA
Output	Breakdown voltage	V _B	I _B =50μA, I _F =10mA	60	-	-	V
	Off-state leakage current	I _{LEAK}	V _L =60V, I _F =5mA	-	1.0	2.0	μΑ
I/O capacitance		C _{iso}	V _B =0V, f=1MHz	-	6	-	pF
ON resistance		R _{ON}	I _F =0mA, I _L =100mA	-	2.5	5	Ω
Reverse (ON) time		T _{ON}	I _F =10mA, V _L =20V	-	0.6	1.5	ms
Operate (OFF) time		T _{OFF}	I _L =100mA, t=10ms - 0.3		0.3	1.5	ms

• Turn-on / Turn-of Time





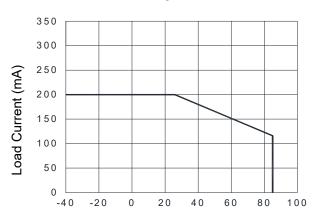
4PIN 60V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Schematic and Wiring Diagrams

Schematic	Output Configuration	Load	Connection	Wiring Diagrams	
2 3	1b	AC DC	-	V _{IN} I _F V _L (AC,DC)	

4PIN 60V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Fig.1 Load Current vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.3 Operate (OFF) Time vs. Ambient Temperature

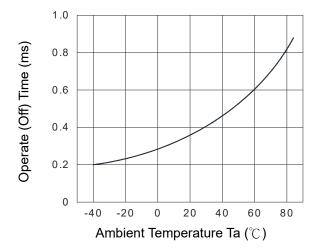


Fig.5 LED Operate Current vs. Ambient Temperature

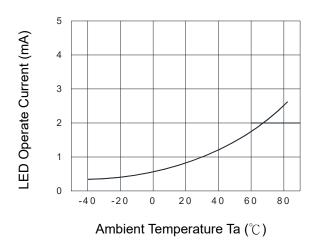
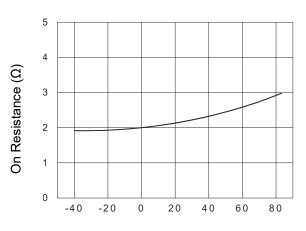


Fig.2 On Resistance vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.4 Reverse (ON) Time vs. Ambient Temperature

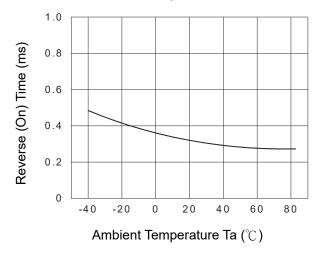
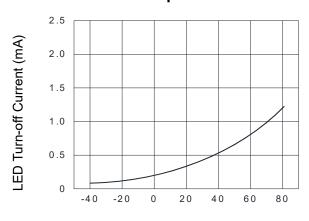


Fig.6 LED Turn-off Current vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.7 LED Dropout Voltage vs. Ambient Temperature

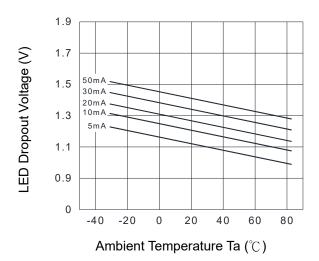


Fig.9 Operate (OFF) Time vs. LED Forward Current

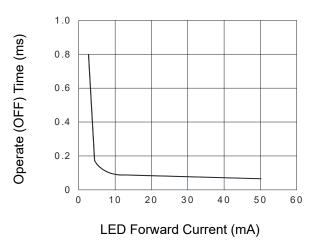


Fig.11 Reverse (ON) Time vs. LED Forward Current

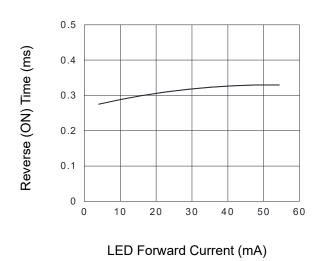
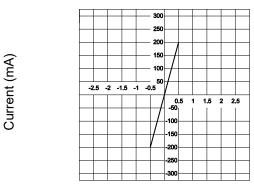


Fig.8 Voltage vs. Current Characteristics of Output at MOSFET Portion



Voltage (V)

Fig.10 Off-state Leakage Current vs. Load Voltage

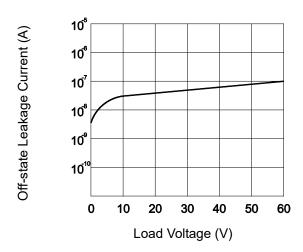
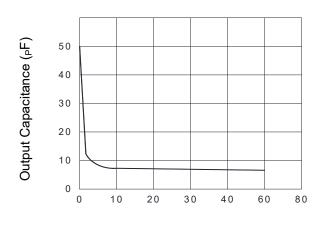


Fig.12 Output Capacitance vs. Applied Voltage

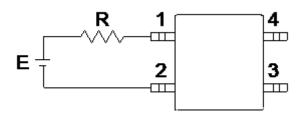


Applied Voltage (V)



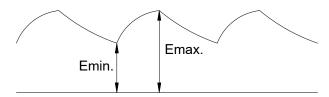
Using Methods

Examples of resistance value to control LED forward current (I_F=5mA)

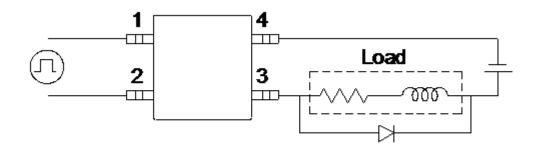


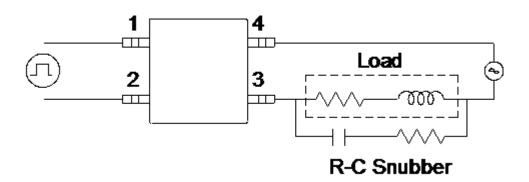
E	R	
3.3V	Approx. 330 Ω	
5V	Approx. 640 Ω	
12V	Approx. 1.9K Ω	
15V	Approx. 2.5K Ω	
24V	Approx. 4.1K Ω	

- 1. LED forward current must be more than 5mA, at E min.
- 2. LED forward current must be less than 50mA, at E max.



Regulate the spike voltage generated on the inductive load as follows:







KAQY412 Series 4PIN 60V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Recommended Soldering Conditions

(a) Infrared reflow soldering:

■ Peak reflow soldering : 260°C or below (package surface temperature)

■ Time of peak reflow temperature: 10 sec
 ■ Time of temperature higher than 230°C: 30-60 sec
 ■ Time to preheat temperature from 60-120 sec

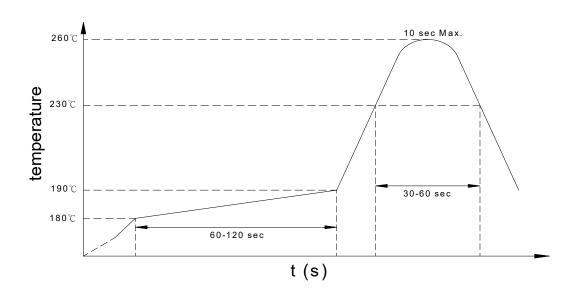
180~190°C : Two

■ Number of reflows : Rosin flux containing small amount of chlorine

■ Flux: (The flux with a maximum chlorine content of 0.2

Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering:

■ Temperature : 260°C or below (molten solder temperature)

■ Time: 10 seconds or less

■ Preheating conditions: 120°C or below (package surface temperature)

■ Number of times : One

■ Flux : Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions:

■ Fluxes : Avoid removing the residual flux with freon-based and

chlorine-based cleaning solvent.

Avoid shorting between portion of frame and leads.



Numbering System

KAQY412 <u>X</u> (Y)

Note:

KAQY412 = Part No.

X = Lead form option (blank · S or A)

Y = Tape and reel option (TLD · TRU)

Option	Description	Packing quantity	
A (TLD)	surface mount type package + TLD tape & reel option	2000 units per reel	
A (TRU)	surface mount type package + TRU tape & reel option	2000 units per reel	
S (TLD)	small outline for surface mount type package +	3000 units per reel	
O (ILD)	TLD tape & reel option	oooo ariita per reer	
C (TDII)	small outline for surface mount type package +	2000 units per real	
S (TRU)	TRU tape & reel option	3000 units per reel	

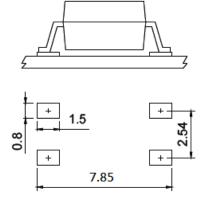
• Recommended Pad Layout for Surface Mount Lead Form

1. Surface mount type.

4-pin SMD + 1.9 + 2.7 8.3

2. Small outline for surface mount type.

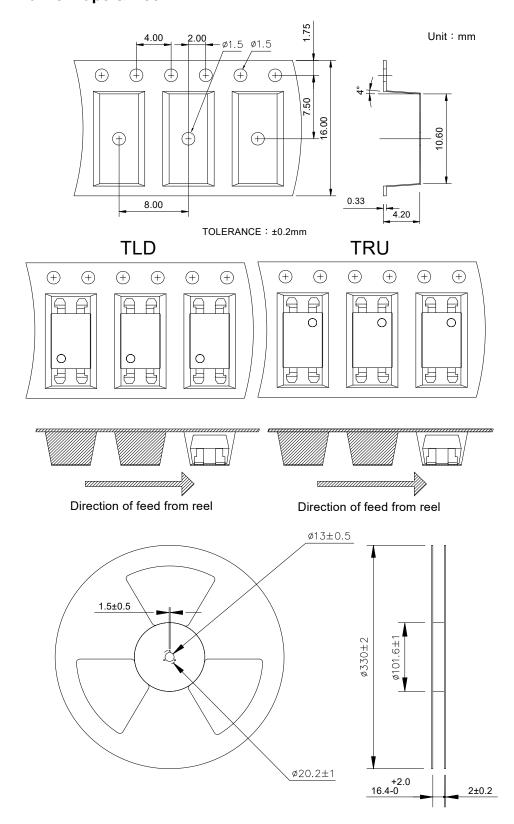
4-pin SOP



Unit: mm

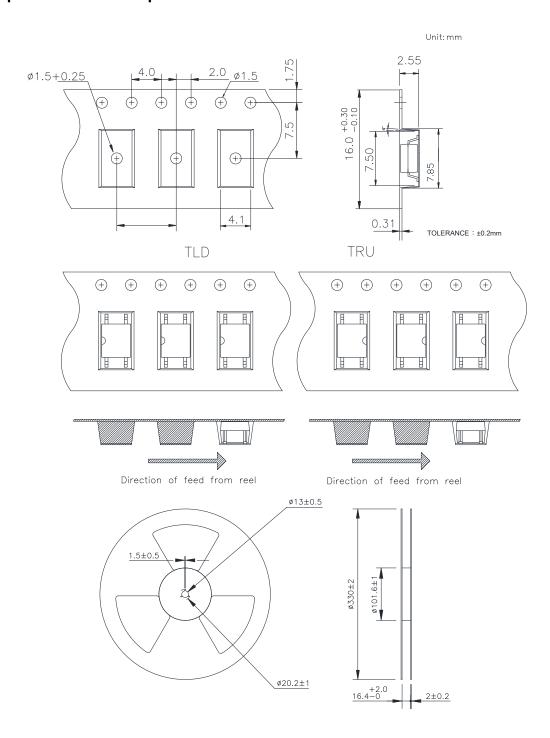


• 4-pin SMD Carrier Tape & Reel



4PIN 60V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

• 4-pin SOP Carrier Tape & Reel



KAQY412 Series 4PIN 60V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Application Notice

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